# **BLP15M9S70G**

Power LDMOS transistor Rev. 4 — 12 January 2023

#### **Product profile** 1.

## 1.1 General description

A 70 W general purpose LDMOS RF power transistor for broadcast and ISM applications in HF to 2 GHz band.

#### Table 1. **Application performance**

| Test signal | f     | PL  | Gp   | η <sub>D</sub> | RL <sub>in</sub> |
|-------------|-------|-----|------|----------------|------------------|
|             | (MHz) | (W) | (dB) | (%)            | (dB)             |
| pulsed CW   | 1400  | 70  | 17.6 | 70             | -14              |
| CW          | 915   | 70  | 17   | 75             | -17              |

## 1.2 Features and benefits

- High efficiency
- Integrated dual sided ESD protection
- Excellent ruggedness
- High power gain
- Excellent reliability
- Easy power control
- For RoHS compliance see the product details on the Ampleon website

## 1.3 Applications

- Industrial, scientific and medical applications
- Broadcast transmitter applications
- RF power amplifiers for CW applications

## 2. Pinning information

| Pin | Description | Simplified outline | Graphic symbol                          |
|-----|-------------|--------------------|---|
| 1   | drain       | 2                  |   |
| 2   | gate        |                    | 1<br>لــــا                             |
| 3   | source      |                    | 2 – – – – – – – – – – – – – – – – – – – |

[1] Connected to flange.

## 3. Ordering information

## Table 3. Ordering information

| Package name | Orderable part number | 12NC           | Packing description             | Min. orderable<br>quantity (pieces) |
|--------------|-----------------------|----------------|---------------------------------|-------------------------------------|
| TO-270-2G-1  | BLP15M9S70GZ          | 9349 602 44515 | TR13; 500-fold; 24 mm; dry pack | 500                                 |
|              | BLP15M9S70GXY         | 9349 602 44538 | TR7; 100-fold; 24 mm; dry pack  | 100                                 |

## 4. Limiting values

### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter            | Conditions | Min | Max  | Unit |
|------------------|----------------------|------------|-----|------|------|
| V <sub>DS</sub>  | drain-source voltage |            | -   | 65   | V    |
| V <sub>GS</sub>  | gate-source voltage  |            | -6  | +13  | V    |
| T <sub>stg</sub> | storage temperature  |            | -65 | +150 | °C   |
| Tj               | junction temperature | [1]        | -   | 225  | °C   |

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the online MTF calculator.

## 5. Thermal characteristics

### Table 5. Thermal characteristics

| Symbol               | Parameter                                | Conditions  | Тур | Unit |
|----------------------|--|---|-----|------|
| R <sub>th(j-c)</sub> | thermal resistance from junction to case | $T_{case} = 85 \text{ °C}; V_{DS} = 32 \text{ V};$ $P_{L} = 70 \text{ W}$ | 1.0 | K/W  |

## 6. Characteristics

## Table 6.DC characteristics

 $T_i = 25 \ ^{\circ}C$ ; unless otherwise specified.

| Symbol               | Parameter                        | Conditions  | Min | Тур  | Max | Unit |
|----------------------|----------------------------------|---|-----|------|-----|------|
| V <sub>(BR)DSS</sub> | drain-source breakdown voltage   | $V_{GS} = 0 \text{ V}; \text{ I}_{D} = 0.66 \text{ mA}$ | 65  | 70   | -   | V    |
| V <sub>GS(th)</sub>  | gate-source threshold voltage    | V <sub>DS</sub> = 10 V; I <sub>D</sub> = 66 mA          | 1.5 | 2.0  | 2.5 | V    |
| I <sub>DSS</sub>     | drain leakage current            | V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 32 V           | -   | -    | 1.4 | μΑ   |
| I <sub>DSX</sub>     | drain cut-off current            | $V_{GS} = V_{GS(th)} + 3.75 V;$<br>$V_{DS} = 10 V$      | -   | 12.6 | -   | A    |
| I <sub>GSS</sub>     | gate leakage current             | V <sub>GS</sub> = 11 V; V <sub>DS</sub> = 0 V           | -   | -    | 140 | nA   |
| R <sub>DS(on)</sub>  | drain-source on-state resistance | $V_{GS} = V_{GS(th)} + 3.75 V;$<br>$I_D = 2.31 A$       | -   | 185  | -   | mΩ   |

## Table 7.AC characteristics

 $T_i = 25 \ ^{\circ}C$ ; unless otherwise specified.

| Symbol           | Parameter                    | Conditions                               | Min | Тур  | Max | Unit |
|------------------|------------------------------|--|-----|------|-----|------|
| C <sub>iss</sub> | input capacitance            | $V_{GS} = 0 V; V_{DS} = 50 V; f = 1 MHz$ | -   | 61   | -   | pF   |
| C <sub>oss</sub> | output capacitance           | $V_{GS} = 0 V; V_{DS} = 50 V; f = 1 MHz$ | -   | 22   | -   | pF   |
| C <sub>rss</sub> | reverse transfer capacitance | $V_{GS} = 0 V; V_{DS} = 50 V; f = 1 MHz$ | -   | 0.45 | -   | pF   |

### Table 8. RF characteristics

RF characteristics in Ampleon production test circuit; typical RF performance at  $T_{case} = 25 \ ^{\circ}C$ ;  $V_{DS} = 32 \ ^{\circ}V$ :  $I_{Dq} = 300 \ m$ A;  $t_p = 100 \ \mu$ s;  $\delta = 10 \ ^{\circ}N$ .

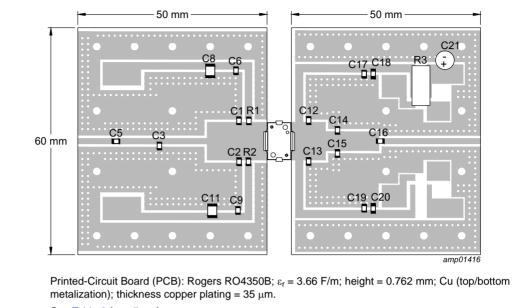
| Symbol           | Parameter           | Conditions                          | Min  | Тур  | Max | Unit |
|------------------|---------------------|-------------------------------------|------|------|-----|------|
| Pulsed R         | Pulsed RF, class-AB |                                     |      |      |     |      |
| Gp               | power gain          | f = 1400 MHz; P <sub>L</sub> = 70 W | 15.5 | 17.6 | -   | dB   |
| η <sub>D</sub>   | drain efficiency    | f = 1400 MHz; P <sub>L</sub> = 70 W | 66   | 70   | -   | %    |
| RL <sub>in</sub> | input return loss   | f = 1400 MHz; P <sub>L</sub> = 70 W | -    | -20  | -   | dB   |

## 7. Test information

## 7.1 Ruggedness in class-AB operation

The BLP15M9S70G is capable of withstanding a load mismatch corresponding to a VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS}$  = 32 V; f = 1400 MHz at rated load power on RF development board using a pulsed CW RF signal which has ~150 ns rise and fall time.

## 7.2 Test circuit



See Table 9 for a list of components.

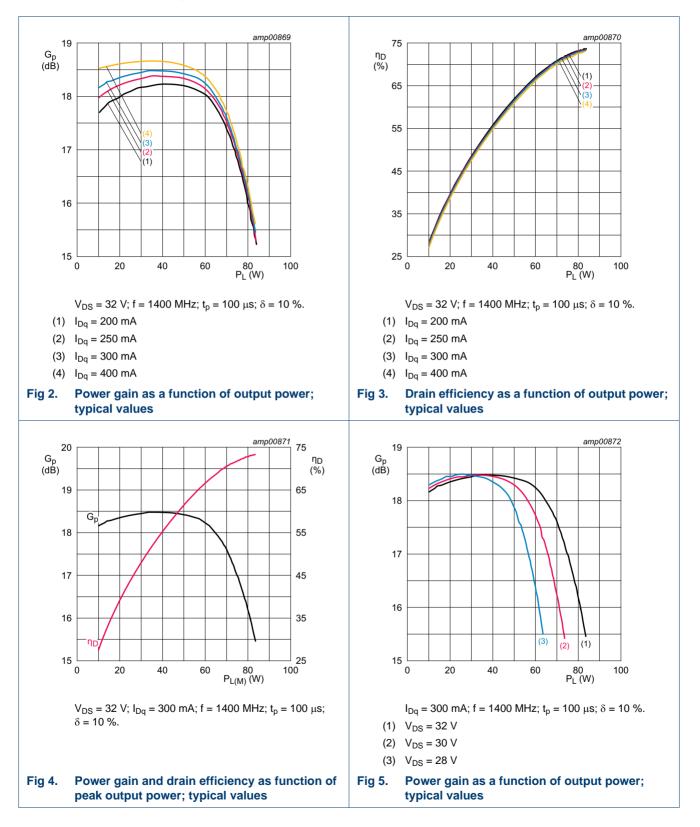
#### Fig 1. **Component layout for production RF Test Circuit**

#### Table 9. List of components Se

| iee <u>Figure 1</u> | for component | layout. |
|---------------------|---------------|---------|
|---------------------|---------------|---------|

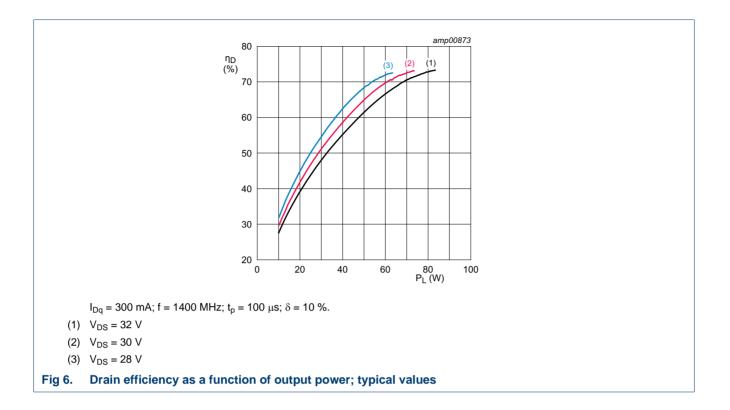
| Component                 | Description                       | Value         | Remarks                   |
|---------------------------|-----------------------------------|---------------|---------------------------|
| C1, C2                    | multilayer ceramic chip capacitor | 6.2 pF        | ATC 800A                  |
| C3                        | multilayer ceramic chip capacitor | 2 pF          | ATC 800A                  |
| C5, C6, C9, C17, C19, C16 | multilayer ceramic chip capacitor | 100 pF        | ATC 800A                  |
| C8, C11, C18, C20         | multilayer ceramic chip capacitor | 100 nF, 100 V |                           |
| C12, C13                  | multilayer ceramic chip capacitor | 3 pF          | ATC 800A                  |
| C14, C15                  | multilayer ceramic chip capacitor | 2.1 pF        | ATC 800A                  |
| C21                       | electrolytic capacitor            | 220 μF, 63 V  |                           |
| R1, R2                    | chip resistor                     | 10 Ω          | SMD 0805                  |
| R3                        | shunt resistor                    | 10 mΩ         | for current<br>monitoring |

7.3 Graphical data

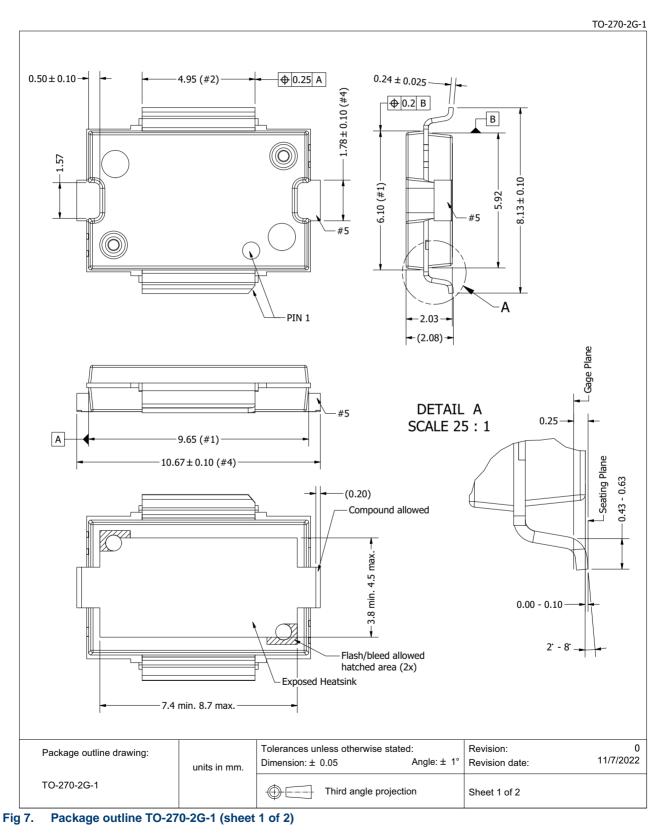


# AMPLEON

# BLP15M9S70G Power LDMOS transistor



## 8. Package outline



BLP15M9S70G

# BLP15M9S70G Power LDMOS transistor

### TO-270-2G-1

|  |   |                     | Drawing Notes   |     |  |  |
|--|---|---------------------|---|-----|--|--|
| Items  |   |                     | Description   |     |  |  |
|  | Dimensions are exc  | luding mold protru  | rusion. The mold protrusion is maximum 0.15 mm per side. See also detail B.   |     |  |  |
| (1) In the dambar area max. protrusion is 0.55mm max. in lenght and 0.3 mm max. in width (4x) See also detail B. |   |                     |   |     |  |  |
| (2)  | (2) The lead dambar (metal) protrusions are not included. Add 0.14 mm max to the total lead dimension at the dambar location. |                     |   |     |  |  |
| (3)  | (3) The leads and exposed heatsink are plated with matte Tin (Sn).  |                     |   |     |  |  |
|  | Dimensions (Heatsink ears) 10,67 and 1,78 do not include mouldprotrusion. Overall Max. dimensions incl. mould                 |                     |   |     |  |  |
| (4)  | (4) protrusions is 10,92 mm. (max.) and 2,03 mm. (max.).  |                     |   |     |  |  |
| (5)  | Surfaces may rema   | in unplated (not so | solderable surfaces).   |     |  |  |
| B-   |   |                     | DETAIL B<br>SCALE 50 : 1  |     |  |  |
|  |   | Lead Da             | Dambar protrusion (#2)  |     |  |  |
| Package or   | utline drawing:   | Lead Da             | Dambar protrusion (#2)       0.15 max. (#1)         Tolerances unless otherwise stated:       Revision:         Dimension: ± 0.05       Angle: ± 1°         Revision date:       11/7         Third angle projection       Sheet 2 of 2 | /20 |  |  |

### Fig 8. Package outline TO-270-2G-1 (sheet 2 of 2)

BLP15M9S70G

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## 9. Handling information

### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

### Table 10.ESD sensitivity

| ESD model  | Class   |
|--|---------|
| Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002 | C2A [1] |
| Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001     | 2 [2]   |

[1] CDM classification C2A is granted to any part that passes after exposure to an ESD pulse of 500 V.

[2] HBM classification 2 is granted to any part that passes after exposure to an ESD pulse of 2000 V.

## **10. Abbreviations**

| Table 11. Abbreviations |  |  |  |  |
|-------------------------|--|--|--|--|
| Acronym                 | Description                                  |  |  |  |
| CW                      | Continuous Wave                              |  |  |  |
| ESD                     | ElectroStatic Discharge                      |  |  |  |
| ISM                     | Industrial, Scientific and Medical           |  |  |  |
| LDMOS                   | Laterally Diffused Metal-Oxide Semiconductor |  |  |  |
| MTF                     | Median Time to Failure                       |  |  |  |
| RoHS                    | Restriction of Hazardous Substances          |  |  |  |
| SMD                     | Surface Mounted Device                       |  |  |  |
| VSWR                    | Voltage Standing Wave Ratio                  |  |  |  |

## 11. Revision history

### Table 12. Revision history

| Document ID     | Release date   | Data sheet status        | Change notice        | Supersedes      |  |  |
|-----------------|--|--------------------------|----------------------|-----------------|--|--|
| BLP15M9S70G v.4 | 20230112   | Product data sheet       | -                    | BLP15M9S70G v.3 |  |  |
| Modifications:  | • Table 3 on page  | ge 2: package name chang | ed from SOT1483-1 to | TO-270-2G-1     |  |  |
|                 | • <u>Table 5 on page 2</u> : value changed from 1.44 K/W to 1.0 K/W                                    |                          |                      |                 |  |  |
|                 | <ul> <li>Section 8 on page 7: package outline drawing changed from SOT1483-1 to TO-270-2G-1</li> </ul> |                          |                      |                 |  |  |
|                 | <ul> <li><u>Section 12 on page 10</u>: updated section</li> </ul>                                      |                          |                      |                 |  |  |
| BLP15M9S70G v.3 | 20210716   | Product data sheet       | -                    | BLP15M9S70G v.2 |  |  |
| BLP15M9S70G v.2 | 20210223   | Product data sheet       | -                    | BLP15M9S70G v.1 |  |  |
| BLP15M9S70G v.1 | 20200507   | Product data sheet       | -                    | -               |  |  |

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| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup>   | Definition  |
|-----------------------------------|---|---|
| Objective [short] data sheet      | Development   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | eet Qualification This document contains data from the preliminary specification. |   |
| Product [short] data sheet        | Production  | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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